



Product End-of-Life Disassembly Instructions

Product Category: Desktop PC

Marketing Name / Model

[List multiple models if applicable.]

HP EliteDesk 800 G6 Desktop Mini PC/ TPC-Q072-DM

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP Inc. products to remove components and materials requiring selective treatment, as defined by EU directive 2012/19/EC, Waste Electrical and Electronic Equipment (WEEE).

NOTE: Recyclers should sort plastic materials into resin streams for recycling based on the ISO 11469 plastic marking code on the plastic part. For any questions on plastic marking or identification of location of parts or components requiring selective treatment, please contact [HP's Sustainability Contact](#).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment. An "X" in the list of components and parts indicates the product contains the component or part requiring selective treatment

Item Description	Components and parts requiring selective treatments	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA) with a surface greater than 10 sq cm	<input checked="" type="checkbox"/> Main board (MB) PCB <input checked="" type="checkbox"/> Solid state drive (SSD) PCB <input type="checkbox"/> Wireless module PCB <input checked="" type="checkbox"/> External power supply (EPS) PCB <input checked="" type="checkbox"/> External Keyboard (KB) <input checked="" type="checkbox"/> External Mouse <input checked="" type="checkbox"/> Option-1 card : Type-C thunderbolt card PCB <input checked="" type="checkbox"/> Option-2 card : Dual USB-A card PCB <input checked="" type="checkbox"/> RAM PCB	9
Batteries, excluding Li-Ion batteries. This includes standard alkaline, coin or button style batteries		1
Li-Ion batteries. Includes all Li-Ion batteries if more than one is provided with the product (such as a detachable notebook keyboard battery, etc.)	Battery(ies) are attached to the product by: <input type="checkbox"/> screws <input type="checkbox"/> snaps <input type="checkbox"/> adhesive <input type="checkbox"/> other. Explain _____	0
Mercury-containing components. For example, mercury in lamps, display backlights, scanner lamps, switches, batteries		0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm. Includes background illuminated displays with gas discharge lamps	<input type="checkbox"/> Panel LCD	0
Cathode Ray Tubes (CRT)		0
Capacitors / condensers (Containing PCB/PCT)		0

Item Description	Components and parts requiring selective treatments	Quantity of items included in product
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height	[<input type="checkbox"/>] Power Supply capacitor(s) or condenser(s)	0
External electrical cables and cords	<input checked="" type="checkbox"/> [x] AC power cord <input type="checkbox"/> [] Audio, video or data cables <input type="checkbox"/> [] Other:	1
Gas Discharge Lamps		0
Plastics containing Brominated Flame Retardants (not including external electrical cables and cords, PCBs or PCAs already listed as a separate item above)		0
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner. Include the cartridges, print heads, tubes, vent chambers, and service stations.		0
Components and waste containing asbestos		0
Components, parts and materials containing refractory ceramic fibers		0
Components, parts and materials containing radioactive substances		0
Components containing chlorofluorocarbons (CFC), hydrochlorofluorocarbons (HCFC) or hydrofluorocarbons (HFC), hydrocarbons (HC)		0

2.0 Tools Required

List of the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
[x] Screwdriver-1	TORX T15
[x] Screwdriver-2	PHILLIPS #1
[x] Screwdriver-3	Hexagon socket wrench 5mm

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment including the required steps to remove the external enclosure.

1. Removed TOP Case
2. Removed Front Cover
3. Removed HDD Bracket

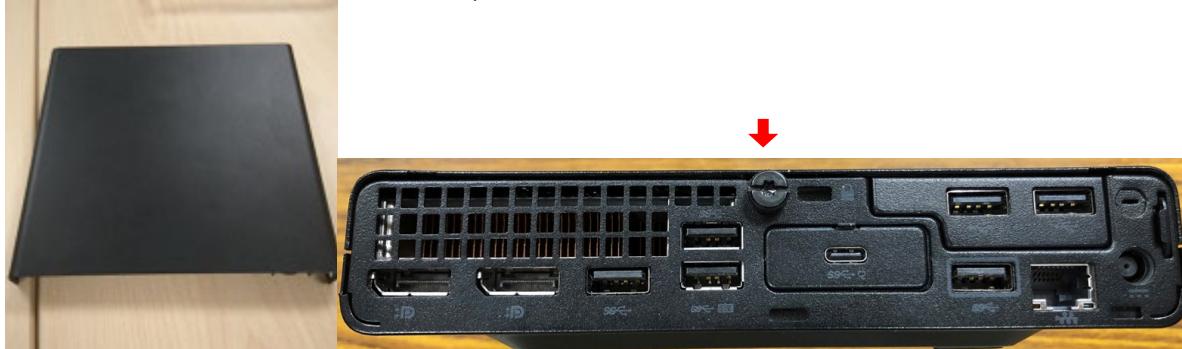
4. Removed HDD
5. Removed Main Fan
6. Removed Thermal Module
7. Removed Motherboard
8. Removed Button Case
9. Removed Option Card
10. Removed SSD and Wireless module
11. Removed RAM PCB and RTC battery

NOTE - For disassembly instructions of the external power supply (EPS), external keyboard (KB) external mouse and external cables and cords, refer to the links below:

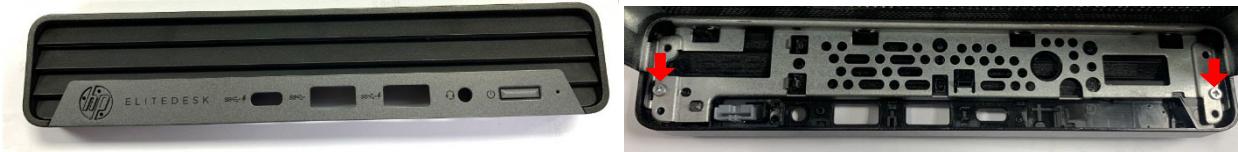
- [Generic External Power Supply \(EPS\)](#)
- [Generic Keyboard](#)
- [Generic Mouse](#)
- [Generic cables and cords](#)

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

1. Removed TOP Case is toolless (hand screw)



2. Removed Front Cover with PHILLIPS #1 screw driver.



3. Removed HDD Bracket with T15 screw driver.



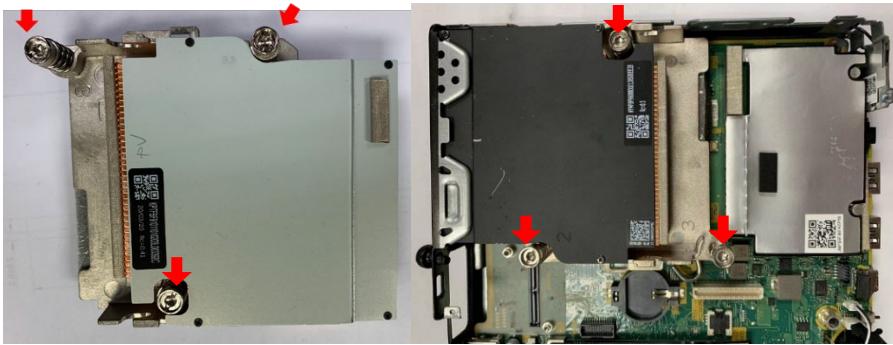
4. Removed HDD Bracket with PHILLIPS #1 screw driver.



5. Removed Main Fan (toolless)



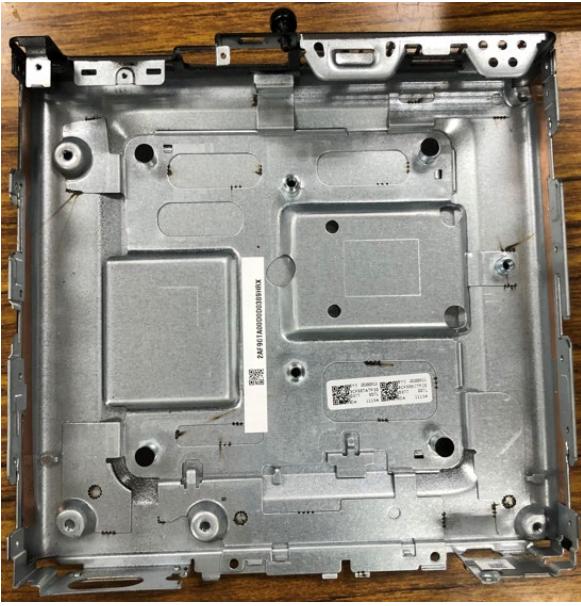
6. Removed Thermal Module with T15 screw driver.



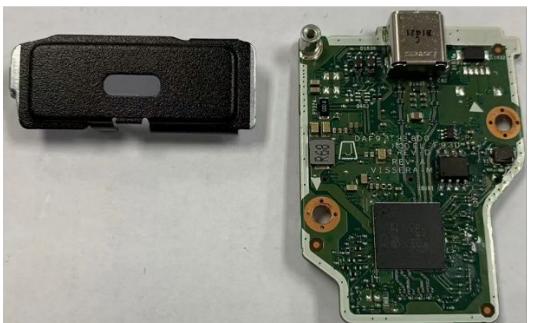
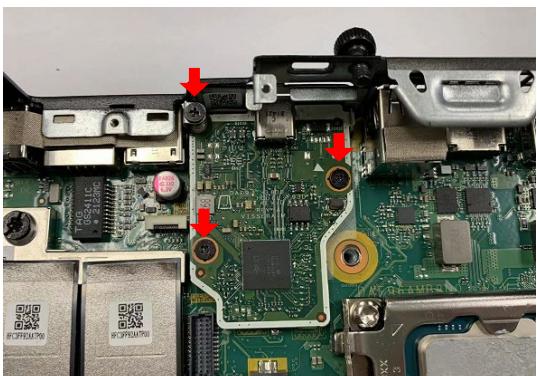
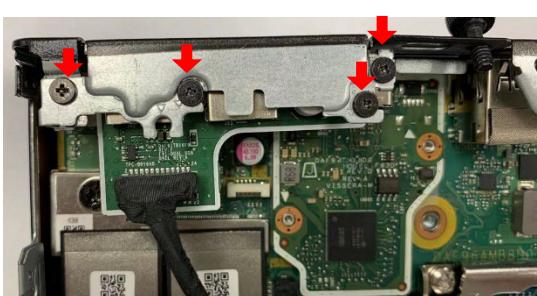
7. Removed Motherboard with T15 screw driver.



8. Removed Bottom Case



9. Removed Option Card with PHILLIPS #1 screw driver.



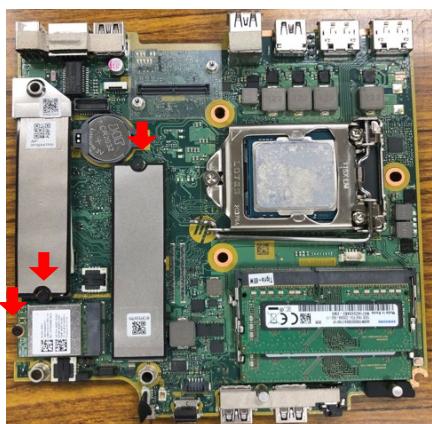
Removed Option-2 serial port Card with hexagon socket wrench 5mm screw driver



Serial port card PCB



10. Removed SSD PCB and Wireless Module PCB with PHILLIPS #1 screw driver.



SSD PCB Wireless Module PCB



11. Removed RAM PCB and RTC battery

